

Photocouplers Photorelay

# TLP171D

#### 1. Applications

- · Mechanical relay replacements
- · Security Systems
- · Modem/Fax PC Cards
- Private Branch Exchanges (PBXs)
- · Measuring Instruments

#### 2. General

The TLP171D photorelay consists of a photo MOSFET optically coupled to an infrared LED. It is housed in a 4-pin package with 2.54-mm lead pitch and 2.1-mm height. This photorelay requires 0.2 mA of LED current to turn it on. It is suitable for applications that need electrical power savings.

#### 3. Features

- (1) Package: SOP(2.54SOP4) (Height 2.1 mm, pitch 2.54 mm)
- (2) Normally opened (1-Form-A)
- (3) OFF-state output terminal voltage: 200 V (min)
- (4) Trigger LED current: 0.1 mA (max)(t≤1s)

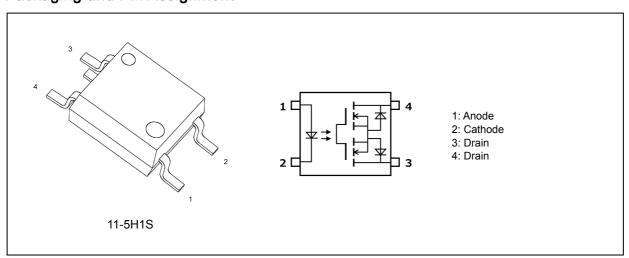
0.2 mA (max)(t > 1 s)

- (5) ON-state current: 200 mA (max)
- (6) ON-state resistance:  $8 \Omega$  (max)
- (7) Isolation voltage: 1500 Vrms (min)
- (8) Safety Standards

UL-recognized: UL 1577, File No.E67349

cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349

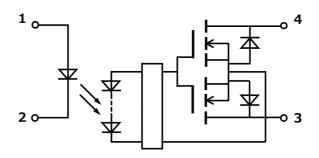
### 4. Packaging and Pin Assignment



Start of commercial production



#### 5. Internal Circuit



### 6. Absolute Maximum Ratings (Note) (Unless otherwise specified, T<sub>a</sub> = 25 °C)

	Characteristics	Symbol	Note	Rating	Unit	
LED	Input forward current		I <sub>F</sub>		30	mA
	Input forward current derating	(T <sub>a</sub> ≥ 25 °C)	ΔI <sub>F</sub> /ΔT <sub>a</sub>		-0.3	mA/°C
	Input forward current (pulsed) (10	00 μs pulse, 100 pps)	I <sub>FP</sub>		1	Α
	Input reverse voltage		V <sub>R</sub>		5	V
	Input power dissipation		$P_{D}$		50	mW
	Input power dissipation derating	(T <sub>a</sub> ≥ 25 °C)	$\Delta P_D/\Delta T_a$		-0.5	mW/°C
	Junction temperature		Tj		125	°C
Detector	OFF-state output terminal voltage		V <sub>OFF</sub>		200	V
	ON-state current		I <sub>ON</sub>		200	mA
	ON-state current derating	(T <sub>a</sub> ≥ 25 °C)	$\Delta I_{ON}/\Delta T_a$		-2.0	mA/°C
	ON-state current (pulsed)	(t = 100 ms)	I <sub>ONP</sub>		600	mA
	Output power dissipation		Po		300	mW
	Output power dissipation derating	(T <sub>a</sub> ≥ 25 °C)	$\Delta P_{O}/\Delta T_{a}$		-3.0	mW/°C
	Junction temperature		Tj		125	°C
Common	Storage temperature		T <sub>stg</sub>		-55 to 125	
	Operating temperature		T <sub>opr</sub>		-40 to 85	
	Lead soldering temperature	(10 s)	T <sub>sol</sub>		260	°C
	Isolation voltage A	C, 60 s, R.H. ≤ 60 %	BV <sub>S</sub>	(Note 1)	1500	Vrms

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

### 7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	$V_{DD}$		_	_	160	V
Input forward current	I <sub>F</sub>		_	0.5	25	mA
ON-state current	I <sub>ON</sub>		_	_	160	mA
Operating temperature	T <sub>opr</sub>	·	-20	_	65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this data sheet should also be considered.



# 8. Electrical Characteristics (Unless otherwise specified, $T_a$ = 25 °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V <sub>F</sub>		I <sub>F</sub> = 10 mA	1.1	1.27	1.4	V
	Input reverse current	I <sub>R</sub>		V <sub>R</sub> = 5 V			10	μΑ
	Input capacitance	Ct		V = 0 V, f = 1 MHz		30	_	pF
Detector	OFF-state current	I <sub>OFF</sub>		V <sub>OFF</sub> = 200 V	_	1	1000	nA
	Output capacitance	C <sub>OFF</sub>		V = 0 V, f = 1 MHz		90	_	pF

## 9. Coupled Electrical Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>		I <sub>ON</sub> = 200 mA, t≤1s	_	0.02	0.1	mA
			I <sub>ON</sub> = 200 mA, t>1s	_	_	0.2	mA
Return LED current	I <sub>FC</sub>		I <sub>OFF</sub> = 100 μA	_	0.001	_	mA
ON-state resistance	R <sub>ON</sub>		I <sub>ON</sub> = 200 mA, I <sub>F</sub> = 0.5 mA, t < 1 s	_	5	8	Ω

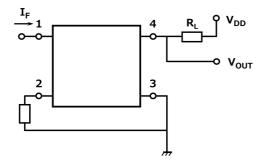
# 10. Isolation Characteristics (Unless otherwise specified, $T_a$ = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V <sub>S</sub> = 0 V, f = 1 MHz	_	8.0		pF
Isolation resistance	R <sub>S</sub>	(Note 1)	$V_S$ = 500 V, R.H. $\leq$ 60 %	5 × 10 <sup>10</sup>	1014		Ω
Isolation voltage	BVS	(Note 1)	AC, 60 s	1500	_	_	Vrms

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

## 11. Switching Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t <sub>ON</sub>		See Fig. 11.1. $R_L = 200 \Omega$ , $V_{DD} = 20 V$ , $I_F = 0.5 mA$	_	3.5	10	ms
			See Fig. 11.1. R <sub>L</sub> = 200 $\Omega$ , V <sub>DD</sub> = 20 V, I <sub>F</sub> = 1.0 mA	_	1.5	5	
Turn-off time	t <sub>OFF</sub>		See Fig. 11.1. R <sub>L</sub> = 200 $\Omega$ , V <sub>DD</sub> = 20 V, I <sub>F</sub> = 0.5 mA	_	1	5	
			See Fig. 11.1. R <sub>L</sub> = 200 $\Omega$ , V <sub>DD</sub> = 20 V, I <sub>F</sub> = 1.0 mA	_	1	5	



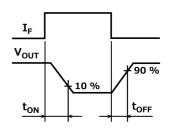


Fig. 11.1 Switching Time Test Circuit and Waveform



#### 12. Characteristics Curves

### 12.1. Characteristics Curves (Note)

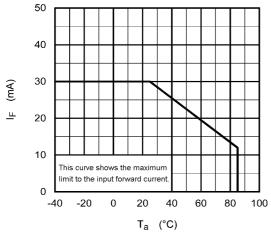


Fig. 12.1.1 I<sub>F</sub> - T<sub>a</sub>

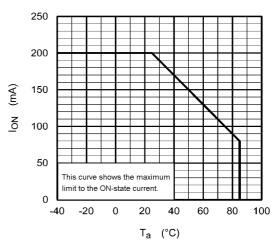


Fig. 12.1.2 I<sub>ON</sub> - T<sub>a</sub>

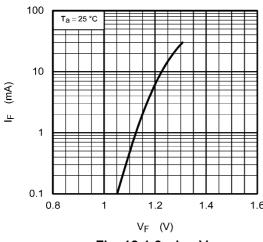


Fig. 12.1.3 I<sub>F</sub> - V<sub>F</sub>

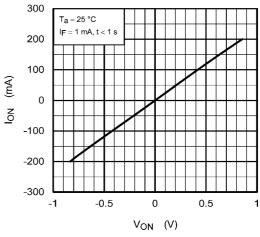


Fig. 12.1.4 I<sub>ON</sub> - V<sub>ON</sub>

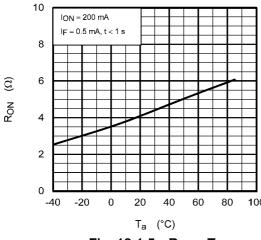


Fig. 12.1.5 R<sub>ON</sub> - T<sub>a</sub>

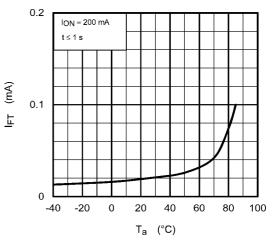


Fig. 12.1.6 I<sub>FT</sub> - T<sub>a</sub>



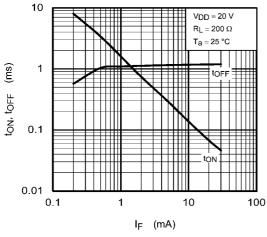


Fig. 12.1.7 t<sub>ON</sub>, t<sub>OFF</sub> - I<sub>F</sub>

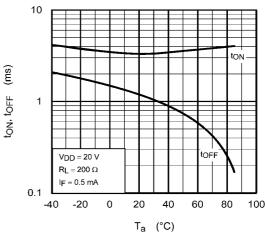


Fig. 12.1.8 t<sub>ON</sub>, t<sub>OFF</sub> - T<sub>a</sub>

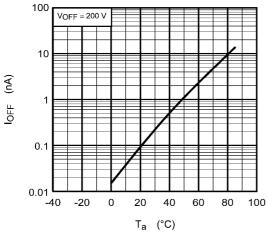


Fig. 12.1.9 I<sub>OFF</sub> - T<sub>a</sub>

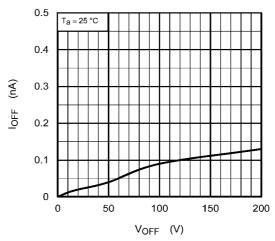


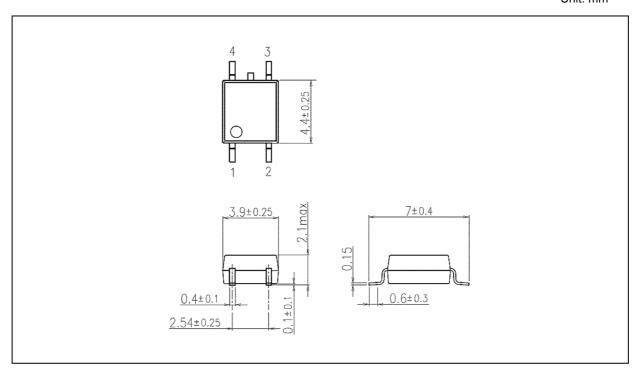
Fig. 12.1.10 I<sub>OFF</sub> - V<sub>OFF</sub>

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



### **Package Dimensions**

Unit: mm



Weight: 0.1 g (typ.)

	Package Name(s)
TOSHIBA: 11-5H1S	



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